

Reliability Monitoring Results

Quarters: Q1/2021 to Q4/2021 Based on structural similarity

SupplierUser Part NumberNexperia B.V.74AHC1G00GV-Q100

Part Description: Single 2-input NAND gate

Function Family: AHC(T)
Process family: Super micron
Package family: TSOP

| JESD47 | | Test Conditions | Duration | # Lots | # Quantity | # Rejects |
|--------|--|---|-----------------------------|-----------|------------|--------------|
| # 1 | TEST Pre- and Post-Stress Electrical Test | Tamb = 25 °C | N/A | see below | all parts | see below |
| # 2 | PC Preconditioning | JESD22-A113 MSL 1 | N/A | 135 | 11128 | 0 |
| # 5a | HTOL EFR High Temperature Operating Life Extrinsic | JESD22-A108 Tj = 150°C $V_{CCMAX} \le V \le 1.2*V_{CCMAX}$ | 48 hours or 168 hours | 128 | 38474 | 0 |
| # 5b | HTOL IFR High Temperature Operating Life Intrinsic | JESD22-A108 Tj = 150°C $V_{CCMAX} \le V \le 1.2*V_{CCMAX}$ | ≥500 hours | 76 | 5079 | 0 |
| # 7 | TC Temperature Cycling | JESD22-A104 -65 °C to 150°C | ≥500 cycles | 64 | 5124 | 0 |
| # 9 | uHAST / HAST unbiased or biased High Accelerated Stress Test | JESD22-A101 Tamb = 130 °C, RH = 85%, V = V _{CCMAX} | 96 hours | 75 | 6004 | 0 |

Calculation of PPM, FIT and MTTF

Test considered for PPM calculation: High Temperature Operating LifeTest Extrinsic (HTOL EFR, Test # 5a above) Test considered for FIT and MTTF calculations: High Temperature Operating LifeTest Intrinsic(HTOL IFR, Test # 5b above)

Confidence level 60%, derated to 55 °C, activation energy 0.7 eV, test time 168 to 1000 hours

| Product Family | Package Family | Quantity | Rejects | Extrinsic Failure Rate (PPM) | Intrinsic Failure Rate (FIT) | MTTF (hrs) |
|-------------------|-------------------|----------|---------|---------------------------------|---------------------------------|------------|
| AHC(T) | TSOP | 5079 | 0 | 24 | 0.7 | 1.57 E+09 |